

INK-RECEPTIVE CARD SUBSTRATE

ABSTRACT OF THE DISCLOSURE

In a method of forming an ink-receptive card substrate, an ink-receptive material
5 is provided. The ink-receptive material includes a backing layer and an ink-receptive coating on a surface of the backing layer. Next, a card member is provided. Finally, the ink-receptive material is laminated to a surface of the card member with the
10 ink-receptive coating facing the surface of the card member. This results in the bonding of the ink-receptive coating to the surface of the card member. Additional embodiments of the present invention are directed to devices that are configured to perform
15 the above-identified method.